

NCE N-Channel Enhancement Mode Power MOSFET

Description

The NCE40H21CD uses advanced trench technology and design to provide excellent $R_{DS(ON)}$ with low gate charge. It can be used in a wide variety of applications.

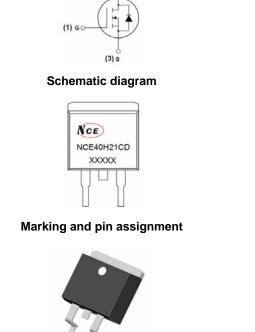
General Features

- V_{DS} =40V ,I_D =210A
 - $R_{DS(ON)} < 2.5m\Omega @ V_{GS}=10V$
- High density cell design for ultra low Rdson
- Fully characterized avalanche voltage and current
- Good stability and uniformity with high E_{AS}
- Excellent package for good heat dissipation
- Special process technology for high ESD capability

Application

- Power switching application
- Hard switched and high frequency circuits
- Uninterruptible power supply

100% UIS TESTED! 100% ΔVds TESTED!



(2) D

TO-263-2L top view

0.48

Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCE40H21CD	NCE40H21CD	TO-263-2L	-	-	-

Absolute Maximum Ratings (T_A=25[°]C unless otherwise noted)

Symbol	Limit	Unit
Vds	40	V
V _{GS}	±20	V
Ι _D	210	А
I _D (100℃)	148	А
I _{DM}	840	А
PD	310	W
	2.07	W/℃
E _{AS}	1800	mJ
TJ,TSTG	-55 To 175	°C
	VDS VGS ID ID ID ID ID ID EAS	VDS 40 VGS ±20 ID 210 ID(100°C) 148 IDM 840 PD 310 EAS 1800

Thermal Resistance, Junction-to-Case^(Note 2)

Electrical Characteristics (T_A=25[°]C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit	
Off Characteristics							
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =250µA	40		-	V	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =40V,V _{GS} =0V	-	-	1	μA	

°C/W



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NCE40H21CD

Parameter	Parameter Symbol Condition		Min	Тур	Max	Unit
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±20V,V _{DS} =0V		-	±100	nA
On Characteristics (Note 3)						
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} ,I _D =250µA	2	3	4	V
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =10V, I _D =40A	-	1.8	2.5	mΩ
Forward Transconductance	g fs	V _{DS} =24V,I _D =40A	160	-	-	S
Dynamic Characteristics (Note4)						
Input Capacitance	C _{lss}		-	7952	-	PF
Output Capacitance	Coss	V _{DS} =25V,V _{GS} =0V, F=1.0MHz	-	1865	-	PF
Reverse Transfer Capacitance	C _{rss}		-	936	-	PF
Switching Characteristics (Note 4)	·					
Turn-on Delay Time	t _{d(on)}		-	25	-	nS
Turn-on Rise Time	tr	VDD=30V,ID=2A,RL=15Ω,	-	75	-	nS
Turn-Off Delay Time	t _{d(off)}	RG=2.5Ω,VGS=10V	-	80	-	nS
Turn-Off Fall Time	t _f		-	60	-	nS
Total Gate Charge	Qg		-	141.3	-	nC
Gate-Source Charge	Q _{gs}	ID=30A,VDD=30V,VGS=10V	-	37.1	-	nC
Gate-Drain Charge	Q _{gd}		-	61.4	-	nC
Drain-Source Diode Characteristics	·					
Diode Forward Voltage (Note 3)	V _{SD}	V _{GS} =0V,I _S =40A	-	0.85	1.2	V
Diode Forward Current (Note 2)	Is		-	-	210	Α
Reverse Recovery Time	t _{rr}	TJ = 25°C, IF = 40A	-	47		nS
Reverse Recovery Charge	Qrr	di/dt = 100A/µs ^(Note3)	-	76		nC
Forward Turn-On Time	t _{on}	Intrinsic turn-on time is negligi	ble (turr	-on is do	minated b	y LS+LD)

Notes:

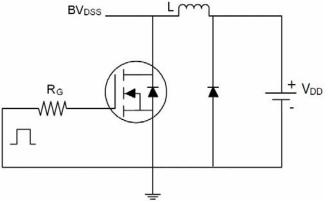
- **1.** Repetitive Rating: Pulse width limited by maximum junction temperature.
- **2.** Surface Mounted on FR4 Board, $t \le 10$ sec.
- **3.** Pulse Test: Pulse Width \leq 300µs, Duty Cycle \leq 2%.
- 4. Guaranteed by design, not subject to production
- 5. EAS condition: Tj=25 $^\circ \! \mathbb{C}$,V_DD=20V,V_G=10V,L=1mH,Rg=25 Ω



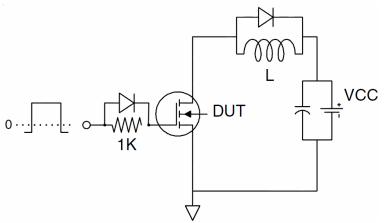
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Test circuit

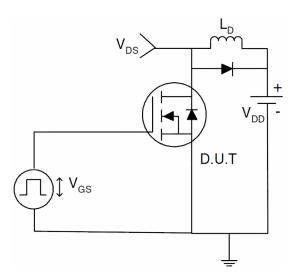
1) E_{AS} test Circuits



2) Gate charge test Circuit:

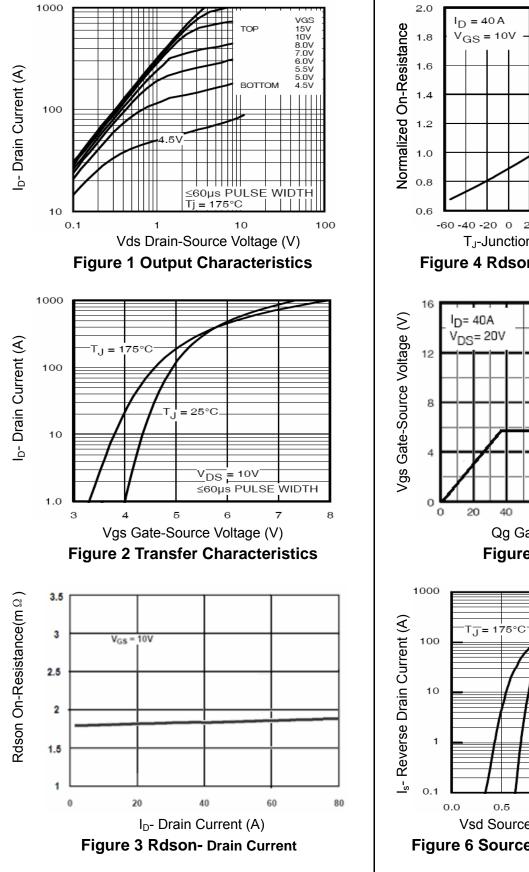


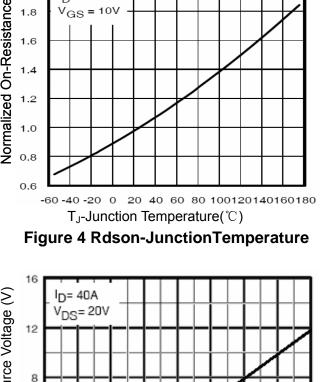
3) Switch Time Test Circuit:

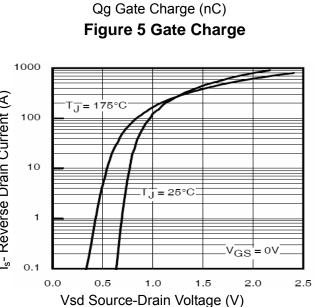




Typical Electrical and Thermal Characteristics (Curves)







60

80

100

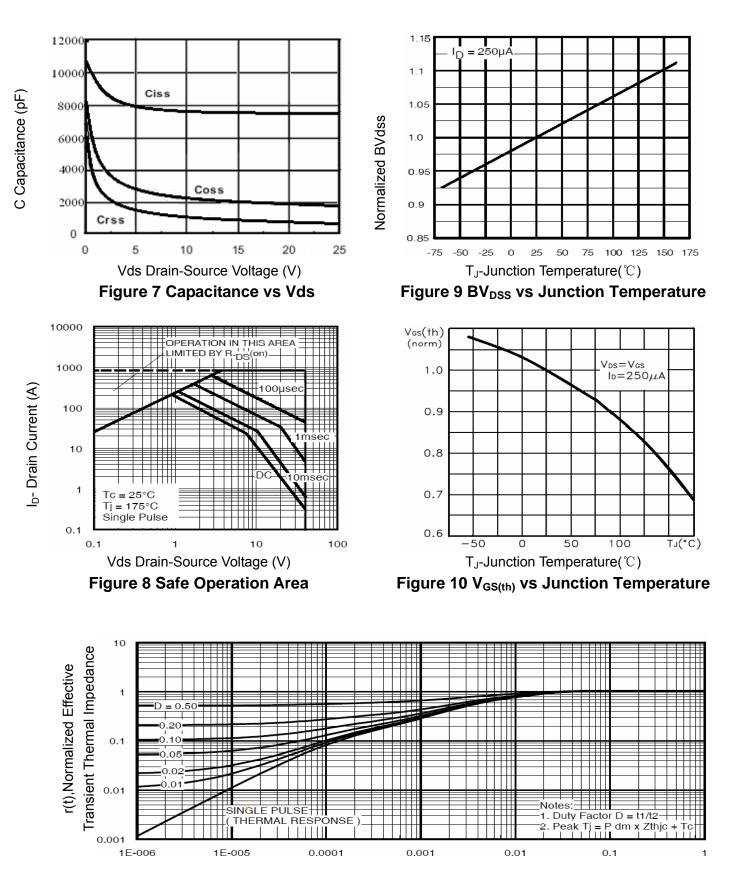
120

140

160

Figure 6 Source- Drain Diode Forward



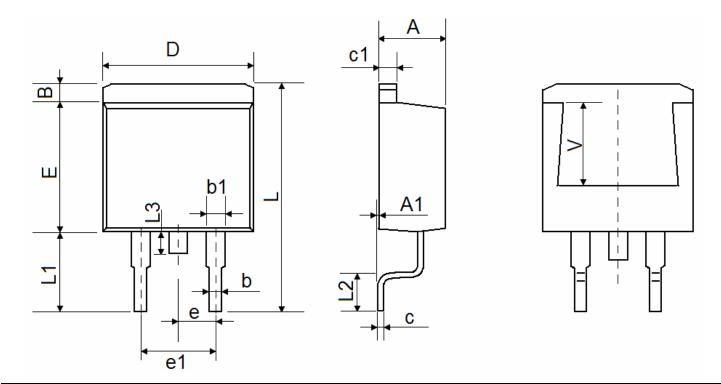


Square Wave Pluse Duration (sec) Figure 11 Normalized Maximum Transient Thermal Impedance



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TO-263-2L Package Information



Symbol	Dimensions I	n Millimeters	Dimensions In Inches		
Symbol	Min.	Max.	Min.	Max.	
A	4.470	4.670	0.176	0.184	
A1	0.000	0.150	0.000	0.006	
В	1.170	1.370	0.046	0.054	
b	0.710	0.910	0.028	0.036	
b1	1.170	1.370	0.046	0.054	
с	0.310	0.530	0.012	0.021	
c1	1.170	1.370	0.046	0.054	
D	10.010	10.310	0.394	0.406	
E	8.500	8.900	0.335	0.350	
е	2.540	TYP.	0.100	́Р.	
e1	4.980	5.180	0.196	0.204	
L	15.050	15.450	0.593	0.608	
L1	5.080	5.480	0.200	0.216	
L2	2.340	2.740	0.092	0.108	
L3	1.300	1.700	0.051	0.067	
V	5.600	REF	0.220 REF		



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